

## P-Channel Enhancement Mode Power MOSFET

#### **DESCRIPTION**

The HM35P03D uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V.

#### **GENERAL FEATURES**

•  $V_{DS} = -30V, I_{D} = -35A$ 

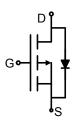
 $R_{DS(ON)}$  < 10m $\Omega$  @  $V_{GS}$ =-10V

 $R_{DS(ON)}$  <15m $\Omega$  @  $V_{GS}$ =-4.5V

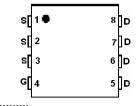
- High Power and current handing capability
- Lead free product is acquired
- Surface Mount Package

## **Application**

- Battery Switch
- Load switch
- Power management



Schematic diagram



Marking and pin assignment

## **Package Marking And Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
HM35P03D	HM35P03D	DFN5X6-8L	Ø330mm	2500 units	12mm

## Absolute Maximum Ratings (TA=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	-30	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous	I <sub>D</sub>	-35	Α
Drain Current-Pulsed (Note 1)	I <sub>DM</sub>	-105	Α
Maximum Power Dissipation	P <sub>D</sub>	75	W
Operating Junction and Storage Temperature Range	$T_{J}$ , $T_{STG}$	-55 To 150	$^{\circ}$ C

#### **Thermal Characteristic**

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ heta JA}$	40	°C/W
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#### Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =-250μA	-30	-33	-	V

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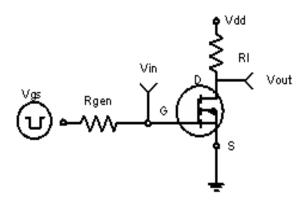
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Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ =-30 $V$ , $V_{GS}$ =0 $V$	-	-	-1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}$ =±20V, $V_{DS}$ =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =-250μA	-1	-1.75	-2.2	V
Drain Course On State Desistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-10A	-	8	10	mΩ
Drain-Source On-State Resistance		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-7.0A	-	11.5	15	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =-15V,I <sub>D</sub> =-9.1A	10	-	-	S
Dynamic Characteristics (Note4)	·					
Input Capacitance	C <sub>lss</sub>	\/ 45\/\\ 0\/	-	1600	-	PF
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ =-15V, $V_{GS}$ =0V, F=1.0MHz	-	350	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.UIVIDZ	-	300	-	PF
Switching Characteristics (Note 4)	·					
Turn-on Delay Time	t <sub>d(on)</sub>		-	10	-	nS
Turn-on Rise Time	t <sub>r</sub>	V <sub>DD</sub> =-15V, ID=-1A,	-	15	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =-10V, $R_{GEN}$ =6 $\Omega$	-	110	-	nS
Turn-Off Fall Time	t <sub>f</sub>			70	-	nS
Total Gate Charge	Qg	\/ - 45\/	-	30	-	nC
Gate-Source Charge	$Q_{gs}$	V <sub>DS</sub> =-15V,I <sub>D</sub> =-9.1A	-	5.5	-	nC
Gate-Drain Charge	$Q_{gd}$	V <sub>GS</sub> =-10V	-	8	-	nC
Drain-Source Diode Characteristics				•		ı
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =-2.1A	-	-	-1.2	V
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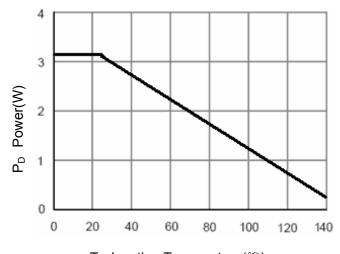
### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

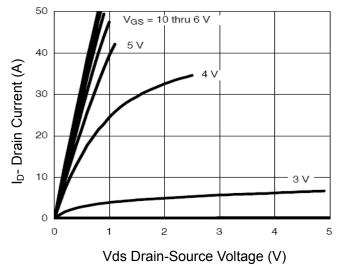


**Figure 1:Switching Test Circuit** 



 $T_J$ -Junction Temperature( ${}^{\circ}\mathbb{C}$ )

Figure 3 Power Dissipation



**Figure 5 Output CHARACTERISTICS** 

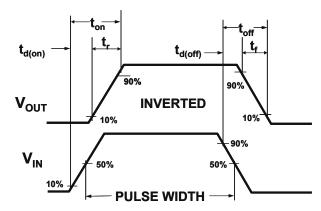
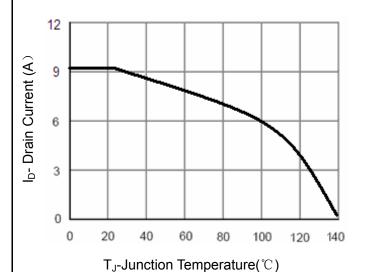


Figure 2:Switching Waveforms



**Figure 4 Drain Current** 

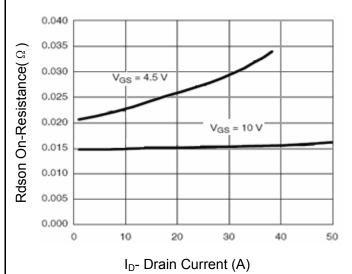
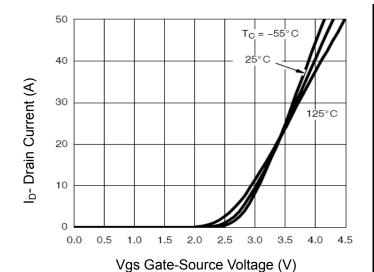


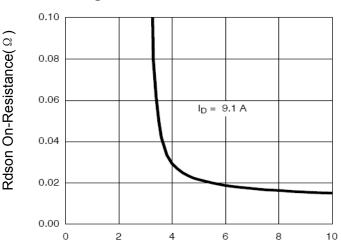
Figure 6 Drain-Source On-Resistance

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**Figure 7 Transfer Characteristics** 



Vgs Gate-Source Voltage (V)
Figure 9 Rdson vs Vgs

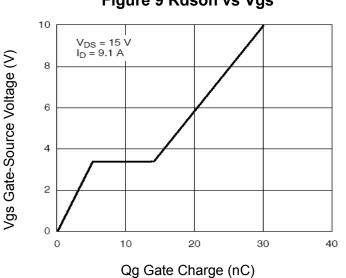


Figure 11 Gate Charge

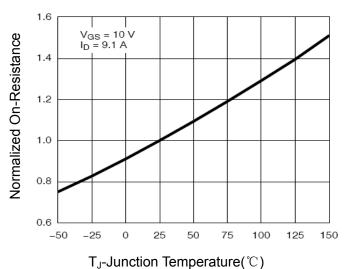


Figure 8 Drain-Source On-Resistance

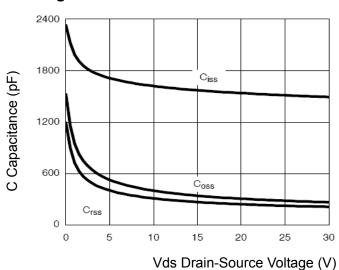


Figure 10 Capacitance vs Vds

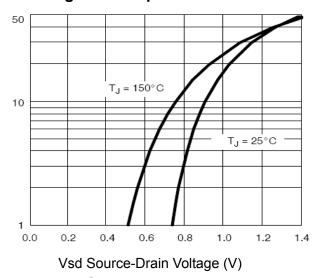
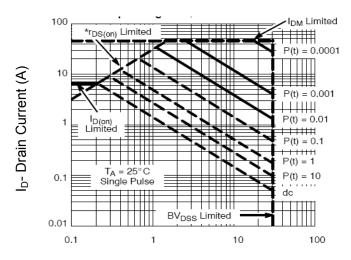


Figure 12 Source- Drain Diode Forward

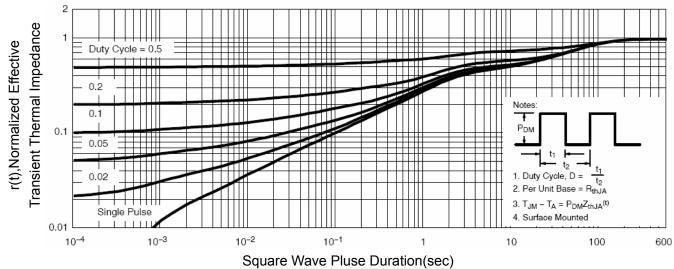
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Is- Reverse Drain Current (A)



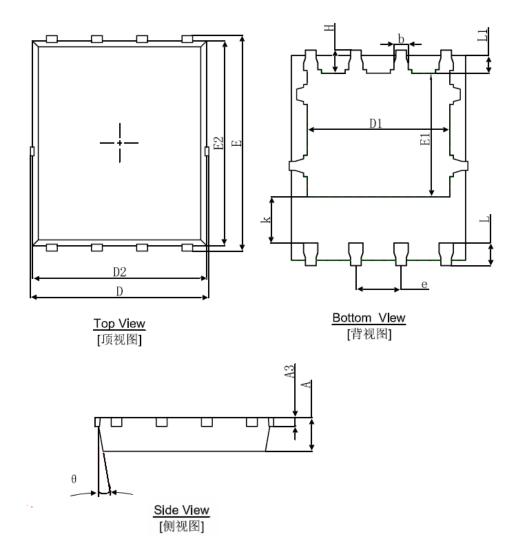
Vds Drain-Source Voltage (V)

Figure 13 Safe Operation Area



**Figure 14 Normalized Maximum Transient Thermal Impedance** 

# **DFN5X6-8L Package Information**



C) male al	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	0.900	1.000	0.035	0.039	
A3	0.254	REF.	0.010	REF.	
D	4.944	5.096	0.195	0.201	
E	5.974	6.126	0.235	0.241	
D1	3.910	4.110	0.154	0.162	
E1	3.375	3.575	0.133	0.141	
D2	4.824	4.976	0.190	0.196	
E2	5.674	5.826	0.223	0.229	
k	1.190	1.390	0.047	0.055	
b	0.350	0.450	0.014	0.018	
е		1.270TYP.		TYP.	
L	0.559	0.711	0.022	0.028	
L1	0.424	0.576	0.017	0.023	
Н	0.574	0.726	0.023	0.029	
θ	8°	12°	8°	12°	

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